

APPLICABLE STANDARD					
RATING	OPERATING TEMPERATURE RANGE	-45°C TO +125°C (NOTES 1)	STORAGE TEMPERATURE RANGE	-10°C TO + 60°C (NOTE2)	
	VOLTAGE	150V AC	APPLICABLE CONNECTOR	DF9#-*S- 1 V (%%)	
	CURRENT	0.5A			
SPECIFICATIONS					
ITEM		TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION					
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING		CONFIRMED VISUALLY.		X	X
ELECTRIC CHARACTERISTICS					
CONTACT RESISTANCE		100m A (DC OR 1000 Hz).	50mΩ MAX.	X	—
INSULATION RESISTANCE		100V DC.	500MΩ MIN.	X	—
VOLTAGE PROOF		250V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	—
MECHANICAL CHARACTERISTICS					
MECHANICAL OPERATION		30TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 50mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
ENVIRONMENTAL CHARACTERISTICS					
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -65→ 5 TO 35→125→ 5 TO 35°C TIME 30→10 TO 15→ 30→10TO15min UNDER 5 CYCLES.	① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.	① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
HEAT RESISTANCE OF SOLDERING		(1)REFLOW SOLDERING 《REFLOW AREA》 MAX250°C, 220°C FOR 60 SECONDS MAX. 《PREHEATING AREA》 150 TO 180°C 90~120 SECONDS. MAXIMUM TWICE ACTION IS ALLOWED UNDER THE SAME CONDITION. (2) MANUAL SOLDELING SOLDERING IRON TEMPERATURE 380°C SOLDERING TIME : WITHIN 3 SECONDS. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	—
SOLDERABILITY		SOLDERING TEMPARATURE:245±5°C DURATION OF IMMERSION : SOLDERING FOR 3±0.5 SECONDS	A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95% OF THE SURFACE BEING IMMERSED.	X	—
					
REMARKS					
NOTE1:INCLUDING THE TEMPERATURE RISE BY CURRENT.					
NOTE2:STORAGEIS DEFINED AS LONG-TERM STORAGE OF UNUSED PRODUCTS.					
APPLY OPERATION TEMPERATURE RANGE TO PRODUCTS MOUNTED ON PCB WITHOUT POWER SUPPLY.					
UNLESS OTHERWISE SPECIFIED , REFER TO JIS C 5402 .					
	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
	1	D1S-H-001216	TR.YUNOKI TR.YUNOKI	TS.MIYAZAKI	06.08.01
			APPROVED	MO.NAKAMURA	05.09.26
			CHECKED	TS.MIYAZAKI	05.09.22
			DESIGNED	TY.001	05.09.22
			DRAWN	HK.MURAKAMI	05.09.14
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWING NO.	ELC4-310706-01	
SPECIFICATION SHEET			PART NO.	DF9C-*P-1V (22)	
HIROSE ELECTRIC CO., LTD.			CODE NO.	CL540	 1/1